

8 Mbit (1Mb x 8) UV EPROM and OTP EPROM

- 5V ± 10% SUPPLY VOLTAGE in READ OPERATION
- ACCESS TIME: 45ns
- LOW POWER CONSUMPTION:
 - Active Current 35mA at 5MHz
 - Standby Current 100µA
- PROGRAMMING VOLTAGE: 12.75V ± 0.25V
- PROGRAMMING TIME: 50µs/word
- **ELECTRONIC SIGNATURE**
 - Manufacturer Code: 20h
 - Device Code: 42h

DESCRIPTION

The M27C801 is an 8 Mbit EPROM offered in the two ranges UV (ultra violet erase) and OTP (one time programmable). It is ideally suited for applications where fast turn-around and pattern experimentation are important requirements and is organized as 1,048,576 by 8 bits.

The FDIP32W (window ceramic frit-seal package) has transparent lid which allows the user to expose the chip to ultraviolet light to erase the bit pattern. A new pattern can then be written to the device by following the programming procedure.

For applications where the content is programmed only one time and erasure is not required, the M27C801 is offered in PDIP32, PLCC32 and TSOP32 (8 x 20 mm) packages.

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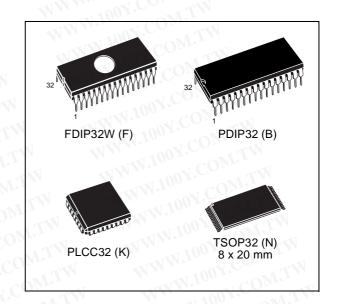
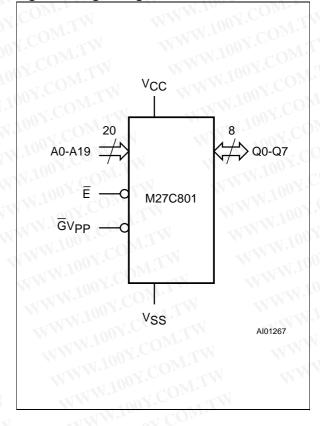


Figure 1. Logic Diagram



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Figure 2A. DIP Connections

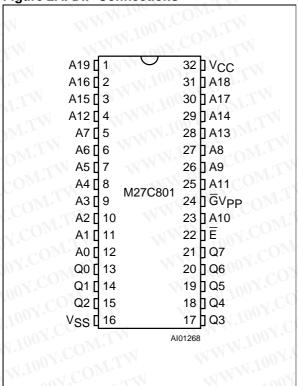


Figure 2B. PLCC Connections

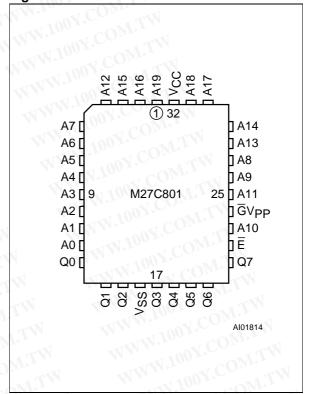


Figure 2C. TSOP Connections

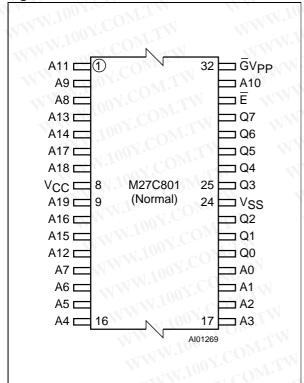


Table 1. Signal Names

A0-A19	Address Inputs
Q0-Q7	Data Outputs
VECONT.	Chip Enable
GV _{PP}	Output Enable / Program Supply
Vcc	Supply Voltage
V _{SS}	Ground

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Table 2. Absolute Maximum Ratings (1)

Symbol	Parameter	Value	Unit
T _A	Ambient Operating Temperature (3)	-40 to 125	°C
T _{BIAS}	Temperature Under Bias	-50 to 125	°C
T _{STG}	Storage Temperature	-65 to 150	°C
V _{IO} (2)	Input or Output Voltage (except A9)	–2 to 7	V
V _{CC}	Supply Voltage	-2 to 7	V
V _{A9} (2)	A9 Voltage	–2 to 13.5	V
V _{PP}	Program Supply Voltage	-2 to 14	V

Note: 1. Except for the rating "Operating Temperature Range", stresses above those listed in the Table "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

2. Minimum DC voltage on Input or Output is -0.5V with possible undershoot to -2.0V for a period less than 20ns. Maximum DC voltage on Output is V_{CC} +0.5V with possible overshoot to V_{CC} +2V for a period less than 20ns.

3. Depends on range.

Table 3. Operating Modes

Mode	WW.E C	GV _{pp}	A9	Q7-Q0
Read	VIL	VIL	X	Data Out
Output Disable	VIL	VIH	X	Hi-Z
Program	V _{IL} Pulse	VPP	X	Data In
Program Inhibit	VIH	COVPP	X X	Hi-Z
Standby	V _{IH}	CCX	X	Hi-Z
Electronic Signature	VIL	VIL	V _{ID}	Codes
			15	

Table 4. Electronic Signature

Identifier	A0	Q7	Q6	Q5	Q4	Q3	Q2	Q1	Q0	Hex Data
Manufacturer's Code	VIL	0	0	1	0	00	0	0	0	20h
Device Code	V _{IH}	0	. 1	0	0	0	0	1 1	0	42h

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Table 5. AC Measurement Conditions

N NWW.Incox.COM.	High Speed	Standard
Input Rise and Fall Times	≤ 10ns	≤ 20ns (10% to 90%)
Input Pulse Voltages	0 to 3V	0.4 to 2.4V
Input and Output Timing Ref. Voltages	1.5V	0.8 and 2V

Figure 3. AC Testing Input Output Waveform

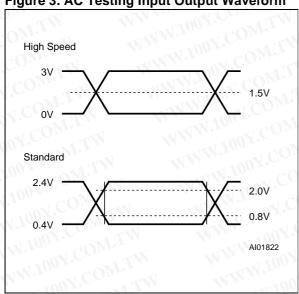


Figure 4. AC Testing Load Circuit

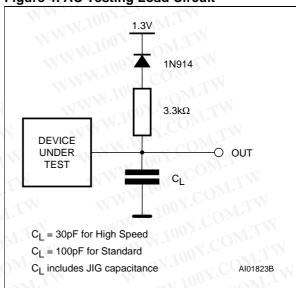


Table 6. Capacitance ⁽¹⁾ ($T_A = 25$ °C, f = 1 MHz)

Symbol	Parameter	Test Condition	Min	Max	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V		6	pF
Cout	Output Capacitance	V _{OUT} = 0V	7.4	12	pF

Note: 1. Sampled only, not 100% tested.

DEVICE OPERATION

The operating modes of the M27C801 are listed in the Operating Modes table. A single power supply is required in the read mode. All inputs are TTL levels except for $\overline{\text{GV}}_{\text{PP}}$ and 12V on A9 for Electronic Signature and Margin Mode Set or Reset.

Read Mode

The M27C801 has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable (\overline{E}) is the power control and should be used for device selection. Output Enable (\overline{G}) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that the ad-

dresses are stable, the address access time (t_{AVQV}) is equal to the delay from \overline{E} to output (t_{ELQV}) . Data is available at the output after a delay of t_{GLQV} from the falling edge of \overline{G} , assuming that \overline{E} has been low and the addresses have been stable for at least t_{AVQV} - t_{GLQV} .

Standby Mode

The M27C801 has a standby mode which reduces the supply current from 35mA to $100\mu A$.

The M27C801 is placed in the standby mode by applying a CMOS high signal to the \overline{E} input. When in the standby mode, the outputs are in a high impedance state, independent of the $\overline{G}V_{PP}$ input.

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Table 7. Read Mode DC Characteristics (1)

 $(T_A = 0 \text{ to } 70 \text{ °C or } -40 \text{ to } 85 \text{ °C}; V_{CC} = 5V \pm 10\%)$

Symbol	Parameter	Test Condition	Min	Max	Unit
N ILI	Input Leakage Current	$0V \le V_{IN} \le V_{CC}$	M.I.	±10	μΑ
ILO	Output Leakage Current	$0V \le V_{OUT} \le V_{CC}$	OWIN	±10	μΑ
Icc	Supply Current	$\overline{E} = V_{IL}, \overline{G}V_{PP} = V_{IL},$ $I_{OUT} = 0mA, f = 5MHz$	COWLIA	35	mA
I _{CC1}	Supply Current (Standby) TTL	$\overline{E} = V_IH$	I.COM	N 1	mA
I _{CC2}	Supply Current (Standby) CMOS	$\overline{E} > V_{CC} - 0.2V$	N.COM	100	μΑ
Olpp	Program Current	$V_{PP} = V_{CC}$	OA'COM.	10	μΑ
VIL	Input Low Voltage	MAN MAN	-0.3	0.8	V
V _{IH} ⁽²⁾	Input High Voltage	MAN.	1002.00	V _{CC} + 1	٧
V _{OL}	Output Low Voltage	I _{OL} = 2.1mA	-1100 Y.Ce	0.4	V
V.CO	Output High Voltage TTL	I _{OH} = -1mA	3.6	WILMO	V
Voн	Output High Voltage CMOS	I _{OH} = -100μA	V _{CC} - 0.7	TY	V

WWW.100Y.COM.T Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP}.

2. Maximum DC voltage on Output is V_{CC} +0.5V.

Table 8A. Read Mode AC Characteristics (1)

	M.C.	MITH WWW.10	OY.COM.	L.M.		M27	C801			TIM
Symbol	Alt	Parameter	Test Condition	-45	5 ⁽³⁾	4/	60	1001	70	Unit
	100X	CO. WITH WHAT	100 Y.CO	Min	Max	Min	Max	Min	Max	M.T
t _{AVQV}	t _{ACC}	Address Valid to Output Valid	$\overline{E} = V_{IL},$ $\overline{G}V_{PP} = V_{IL}$	M.T	45		60	N.10	70	ns
t _{ELQV}	t _{CE}	Chip Enable Low to Output Valid	$\overline{G}V_{PP}=V_{IL}$	O_{Mr} .	45		60	M.	70	ns
t _{GLQV}	toE	Output Enable Low to Output Valid	$\overline{E} = V_{IL}$	CO_{N_0}	25		30	MW.	35	ns
t _{EHQZ} (2)	t _{DF}	Chip Enable High to Output Hi-Z	$\overline{G}V_PP = V_IL$.00	25	(0	25 <	0	30	ns
t _{GHQZ} (2)	t _{DF}	Output Enable High to Output Hi-Z	$\overline{E} = V_{IL}$	10	25	10	25	0	30	ns
t _{AXQX}	tон	Address Transition to Output Transition	$\overline{E} = V_{IL},$ $\overline{G}V_{PP} = V_{IL}$	0	OM	0		0	WW.	ns

Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP}.

2. Sampled only, not 100% tested.

Two Line Output Control

Because EPROMs are usually used in larger memory arrays, the product features a 2 line control function which accommodates the use of multiple memory connection. The two line control function allows:

- a. the lowest possible memory power dissipation,
- b. complete assurance that output bus contention will not occur.

For the most efficient use of these two control lines, E should be decoded and used as the primary device selecting function, while G should be made a common connection to all devices in the array and connected to the READ line from the system control bus. This ensures that all deselected memory devices are in their low power standby mode and that the output pins are only active when data is required from a particular memory

^{3.} Speed obtained with High Speed AC measurement conditions.

Table 8B. Read Mode AC Characteristics (1)

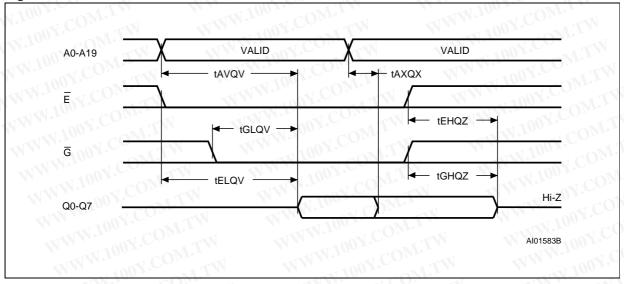
 $(T_A = 0 \text{ to } 70 \text{ °C or } -40 \text{ to } 85 \text{ °C}; V_{CC} = 5V \pm 10\%)$

N	4/1/4	W.1007. COM.TW	W. 100 -	CON	M27	7C801		
Symbol	Alt	Parameter	Test Condition	-{	30	-100/-12	20/-150	Unit
		WW. 100Y. COM.TW	WW.100	Min	Max	Min	Max	
t _{AVQV}	t _{ACC}	Address Valid to Output Valid	$\overline{E} = V_{IL}, \overline{G}V_{PP} = V_{IL}$	10 A . C.	80	W	100	ns
t _{ELQV}	t _{CE}	Chip Enable Low to Output Valid	$\overline{G}V_{PP}=V_{IL}$	001.	80	IM	100	ns
t _{GLQV}	toE	Output Enable Low to Output Valid	E = V _{IL}	1001	40	TW	50	ns
t _{EHQZ} (2)	tDF	Chip Enable High to Output Hi-Z	$\overline{G}V_{PP} = V_{IL}$	0	35	0	40	ns
t _{GHQZ} (2)	t _{DF}	Output Enable High to Output Hi-Z	$\overline{E} = V_{IL}$	0	35	0	40	ns
t _{AXQX}	t _{OH}	Address Transition to Output Transition	$\overline{E} = V_{IL}, \overline{G}V_{PP} = V_{IL}$	0	100 X	0	TW	ns

Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP}.

2. Sampled only, not 100% tested.

Figure 5. Read Mode AC Waveforms



System Considerations

The power switching characteristics of Advanced CMOS EPROMs require careful decoupling of the devices. The supply current, I_{CC} , has three segments that are of interest to the system designer: the standby current level, the active current level, and transient current peaks that are produced by the falling and rising edges of \overline{E} . The magnitude of the transient current peaks is dependent on the capacitive and inductive loading of the device at the output. The associated transient voltage peaks can be suppressed by complying with the two line

output control and by properly selected decoupling capacitors. It is recommended that a 0.1 μF ceramic capacitor be used on every device between V_{CC} and V_{SS} . This should be a high frequency capacitor of low inherent inductance and should be placed as close to the device as possible. In addition, a 4.7 μF bulk electrolytic capacitor should be used between V_{CC} and V_{SS} for every eight devices. The bulk capacitor should be located near the power supply connection point. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of PCB traces.

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Table 9. Programming Mode DC Characteristics (1)

 $(T_A = 25 \text{ °C}; V_{CC} = 6.25 \text{V} \pm 0.25 \text{V}; V_{PP} = 12.75 \text{V} \pm 0.25 \text{V})$

Symbol	Parameter	Test Condition	Min	Max	Unit
N ILI	Input Leakage Current	$V_{IL} \le V_{IN} \le V_{IH}$	COMIT	±10	μΑ
Icc	Supply Current	LA MAN 1001	C.Mon	50	mA
IPP	Program Current	$\overline{E} = V_{IL}$	Y.Co.	50	mA
V _{IL}	Input Low Voltage	CEW WWW.	-0.3	0.8	V
V _{IH}	Input High Voltage	TW WWW.	07.2	V _{CC} + 0.5	V
V _{OL}	Output Low Voltage	I _{OL} = 2.1mA	ON.CO	0.4	V
Voн	Output High Voltage TTL	I _{OH} = -1mA	3.6	TW.	V
V _{ID}	A9 Voltage	COM.	11.5	12.5	V

Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP}.

Table 10. MARGIN MODE AC Characteristics (1)

 $(T_A = 25 \text{ °C}; V_{CC} = 6.25 \text{V} \pm 0.25 \text{V}; V_{PP} = 12.75 \text{V} \pm 0.25 \text{V})$

Symbol	Alt	Parameter	Test Condition	Min	Max	Unit
t _{A9HVPH}	t _{AS9}	V _{A9} High to V _{PP} High	N TO	102	COMITY	μs
tVPHEL	t _{VPS}	V _{PP} High to Chip Enable Low	N. A.	1,1207	T.MOD	μs
t _{A10} HEH	t _{AS10}	V _{A10} High to Chip Enable High (Set)	di Min	100	MOM	μs
t _{A10} LEH	t _{AS10}	V _{A10} Low to Chip Enable High (Reset)	IN M	1,00	Y.C.	μs
t _{EXA10X}	t _{AH10}	Chip Enable Transition to V _{A10} Transition	W W	1	O.Y.CO.	μs
t _{EXVPX}	t _{VPH}	Chip Enable Transition to V _{PP} Transition	TW	2	MY.CO	μs
t _{VPXA9X}	t _{AH9}	V _{PP} Transition to V _{A9} Transition		2	. ON Y.C.	μs

Note: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP} .

Programming

When delivered (and after each erasure for UV EPROM), all bits of the M27C801 are in the '1' state. Data is introduced by selectively programming '0's into the desired bit locations. Although only '0' will be programmed, both '1's and '0's can be present in the data word. The only way to change a '0' to a '1' is by die exposure to ultraviolet

light (UV EPROM). The M27C801 is in the programming mode when V_{PP} input is at 12.75V and \bar{E} is pulsed to V_{IL} . The data to be programmed is applied to 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL. V_{CC} is specified to be 6.25V \pm 0.25V.

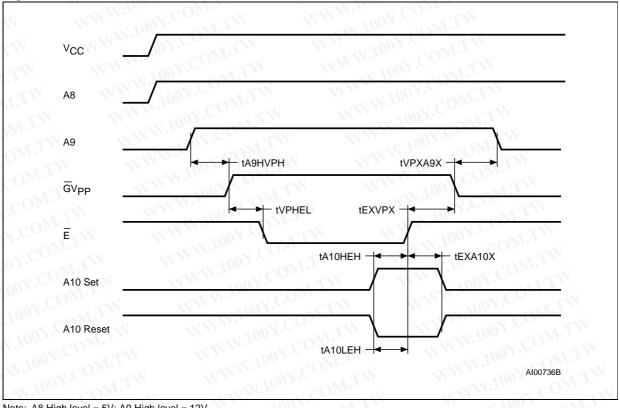
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Note: A8 High level = 5V; A9 High level = 12V.

Table 11. Programming Mode DC Characteristics (1) $(T_A = 25 \text{ °C}; V_{CC} = 6.25 \text{V} \pm 0.25 \text{V}; V_{PP} = 12.75 \text{V} \pm 0.25 \text{V})$

Symbol	Alt	Parameter	Test Condition	Min	Max	Unit
tAVEL	tas	Address Valid to Chip Enable Low	WT I	2	-1100Y	μs
t _{QVEL}	t _{DS}	Input Valid to Chip Enable Low	COM	2	100	μs
tvcheL	tvcs	V _{CC} High to Chip Enable Low	COM	2	111.	μs
t _{VPHEL}	toes	V _{PP} High to Chip Enable Low	V.COM.	2	MM.To	μs
t _{VPLVPH}	t _{PRT}	V _{PP} Rise Time	COM	50	UWW.I	ns
tELEH	t _{PW}	Chip Enable Program Pulse Width (Initial)	a COM.	45	55	μs
t _{EHQX}	t _{DH}	Chip Enable High to Input Transition	00 r. COW. I.	2		μs
t _{EHVPX}	toeh	Chip Enable High to V _{PP} Transition	1001. COM:1	2		μs
t _{VPLEL}	t _{VR}	V _{PP} Low to Chip Enable Low	V.100Y. COM.	2	1111	μs
t _{ELQV}	t_{DV}	Chip Enable Low to Output Valid	W 100Y.	TW	1	μs
t _{EHQZ} (2)	t _{DFP}	Chip Enable High to Output Hi-Z	100Y.CO	0	130	ns
t _{EHAX}	t _{AH}	Chip Enable High to Address Transition	NATION CO	0	1	ns

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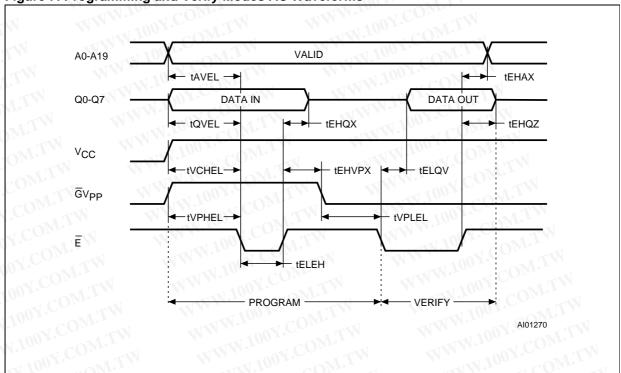
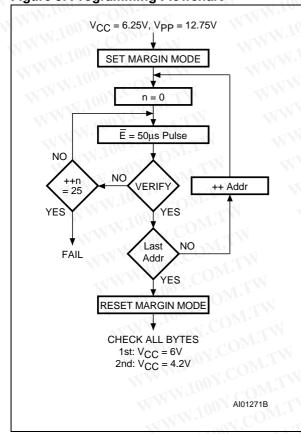


Figure 8. Programming Flowchart



PRESTO IIB Programming Algorithm

PRESTO IIB Programming Algorithm allows the whole array to be programmed with a guaranteed margin, in a typical time of 52.5 seconds. This can be achieved with STMicroelectronics M27C801 due to several design innovations to improve programming efficiency and to provide adequate margin for reliability. Before starting the programming the internal MARGIN MODE circuit is set in order to guarantee that each cell is programmed with enough margin. Then a sequence of 50µs program pulses are applied to each byte until a correct verify occurs. No overprogram pulses are applied since the verify in MARGIN MODE provides the necessary margin.

Program Inhibit

Programming of multiple M27C801s in parallel with different data is also easily accomplished. Except for \overline{E} , all like inputs including $\overline{GV_{PP}}$ of the parallel M27C801 may be common. A TTL low level pulse applied to a M27C801's \overline{E} input, with V_{PP} at 12.75V, will program that M27C801. A high level \overline{E} input inhibits the other M27C801s from being programmed.

Program Verify

A verify (read) should be performed on the programmed bits to determine that they were correctly programmed. The verify is accomplished with \overline{G} at V_{IL} . Data should be verified with t_{ELQV} after the falling edge of \overline{E} .

Electronic Signature

The Electronic Signature (ES) mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and type. This mode is intended for use by programming equipment to automatically match the device to be programmed with its corresponding programming algorithm. The ES mode is functional in the 25°C \pm 5°C ambient temperature range that is required when programming the M27C801. To activate the ES mode, the programming equipment must force 11.5V to 12.5V on address line A9 of the M27C801. Two identifier bytes may then be sequenced from the device outputs by toggling address line A0 from VIL to VIH. All other address lines must be held at VIL during Electronic Signature mode. Byte 0 (A0 = V_{IL}) represents the manufacturer code and byte 1 (A0 = V_{IH}) the device identifier code. For the STMicroelectronics M27C801, these two identifier bytes are given in Table 4 and can be read-out on outputs Q7 to Q0.

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ERASURE OPERATION (applies to UV EPROM)

The erasure characteristics of the M27C801 is such that erasure begins when the cells are exposed to light with wavelengths shorter than approximately 4000 Å. It should be noted that sunlight and some type of fluorescent lamps have wavelengths in the 3000-4000 Å range.

Research shows that constant exposure to room level fluorescent lighting could erase a typical M27C801 in about 3 years, while it would take approximately 1 week to cause erasure when exposed to direct sunlight. If the M27C801 is to be exposed to these types of lighting conditions for extended periods of time, it is suggested that opaque labels be put over the M27C801 window to prevent unintentional erasure. The recommended erasure procedure for the M27C801 is exposure to short wave ultraviolet light which has wavelength 2537 Å. The integrated dose (i.e. UV intensity x exposure time) for erasure should be a minimum of 30 W-sec/cm². The erasure time with this dosage is approximately 30 to 40 minutes using an ultraviolet lamp with 12000 µW/cm² power rating. The M27C801 should be placed within 2.5 cm (1 inch) of the lamp tubes during the erasure. Some lamps have a filter on their tubes which should be removed before erasure. WWW.100Y.COM.

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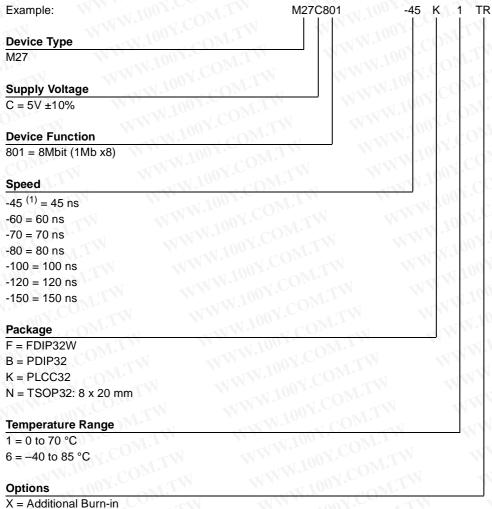
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M27C801





TR = Tape & Reel Packing

Note: 1. High Speed, see AC Characteristics section for further information.

For a list of available options (Speed, Package, etc...) or for further information on any aspect of this device, please contact the STMicroelectronics Sales Office pages to view WWW.100Y.COM.TV vice, please contact the STMicroelectronics Sales Office nearest to you.

Date	Revision Details	
September 1998	First Issue	MMA
03/21/00	FDIP32W Package changed	WW
09/25/00	AN620 Reference removed	W
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<u> </u>	MAN TOOK COWILL MAN TOOK	

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Table 13. FDIP32W - 32 pin Ceramic Frit-seal DIP with window, Package Mechanical Data

Symbol	millimeters			COM.	inches			
Symbol	Тур	Min	Max	Тур	Min	Max		
Α	W. 100	COMIT	5.72	TN.100	M.I.	0.225		
A1	71 100	0.51	1.40	13N.100 Y.	0.020	0.055		
A2	WWW	3.91	4.57	1007.0	0.154	0.180		
А3	MMM.	3.89	4.50	MAL TOOK!	0.153	0.177		
В	WWW.	0.41	0.56	VION.	0.016	0.022		
B1	1.45	TOM.		0.057	CONT.	_		
OMC	W	0.23	0.30	4. 100	0.009	0.012		
DI		41.73	42.04	W.10	1.643	1.655		
D2	38.10	110 0 7.00	MIN	1.500	1. M.T	_		
COE	15.24	MAN TO A CC	W-L	0.600	1001.00	[M -		
CE1	XX XX	13.06	13.36	WWW.	0.514	0.526		
е	2.54	TINN Too	COM-	0.100	· Pa COM	- TW-		
eA	14.99	W.100 -	CONT.	0.590	N.100-1 CO	VI. 2		
o eB	TW	16.18	18.03		0.637	0.710		
1001.Co	WILL	3.18	Y.COM.T		0.125	OMJIA		
SICO	WTD	1.52	2.49		0.060	0.098		
Ø	7.11	MAIN.	W. Com	0.280	100X	777		
α	OM	4°	11°O		4°	C 11°		
NOO X	OWILL	32	Jun 21 CO1		32	COM.		

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Table 14. PDIP32 - 32 pin Plastic DIP, 600 mils width, Package Mechanical Data

Symbol	WW.IO	millimeters		inches		
	Тур	Min	Max	Тур	Min	Max
Α	W.100;	COV	5.08	M. Ind CO	M. F	0.200
A1	W .100	0.38		VIW.100	0.015	_
A2	W 10	3.56	4.06	NW.100	0.140	0.160
В	WW.	0.38	0.51	W.1001.	0.015	0.020
B1	1.52	1007.COM	LM -	0.060	CONTIN	_
C	MMA	0.20	0.30	N N 100	0.008	0.012
D	MM	41.78	42.04	WW 10	1.645	1.655
D2	38.10	M. TOUT.CO	TY	1.500	OY.CO	- N
COE	15.24	M. Pagy.Co	DAY.	0.600	OOX.COS	- W
CE1	N XX	13.59	13.84	WWW.	0.535	0.545
e1	2.54	MAN TOO	COM-	0.100	· LOD	TW-
eA	15.24		$COM_{1,1}$	0.600	N. Jun T. CO	VI. P
eB	C.L.V.	15.24	17.78		0.600	0.700
100F.	WIIN	3.18	3.43		0.125	0.135
SYLVE	M.TW	1.78	2.03	Las A	0.070	0.080
α	MIN	0°	10°	i In	0°	10°
N	WT	32	100 Y.CO.	NTW	32 100	Mo

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Table 15. PLCC32 - 32 lead Plastic Leaded Chip Carrier, Package Mechanical Data

Symbol	WW.Io	millimeters	WWW	inches			
	Тур	Min	Max	Тур	Min	Max	
Α	W.100	2.54	3.56	N.100 -1 CO	0.100	0.140	
A1	WW 100	1.52	2.41	M.1003.	0.060	0.095	
A2	MM	0.38		12N 100 X	0.015		
В	MM	0.33	0.53	1007.	0.013	0.021	
B1	MMM.	0.66	0.81	1003	0.026	0.032	
D	WWW	12.32	12.57	NWW. 100	0.485	0.495	
ON D1	WW	11.35	11.56	WWW.	0.447	0.455	
D2		9.91	10.92	MANITO	0.390	0.430	
е	1.27	W.100	OM.	0.050	COM.,	axN	
EMT		14.86	15.11	W.	0.585	0.595	
E1	N O	13.89	14.10	N V	0.547	0.555	
E2	TW	12.45	13.46	MAL	0.490	0.530	
N.EON	WT	0.00	0.25	MM	0.000	0.010	
R CO	0.89	WWW.	Y.COPT	0.035	100X.C	WIN	
N CO	32			32			
Nd	M. T. Z. W. LOOM.			WWW7 OV.COM			
Ne	9 W.10 COM			9.10 COM			
CP	MIN	1	0.10	T.A.	A. 100	0.004	

Table 16. TSOP32 - 32 lead Plastic Thin Small Outline, 8 x 20 mm, Package Mechanical Data

N Symbol W	Cmillimeters			inches		
Symbol	Тур	Min	Max	Тур	Min	Max
Α	MW.100	COM.	1.20	M.In. CO	W.	0.047
A1	M.100	0.05	0.17	M.Inc.	0.002	0.006
A2	WW.10	0.95	1.05	MM. Jan	0.037	0.041
В	W.	0.15	0.27	MM.100.2	0.006	0.011
C.C.	W	0.10	0.21	11/W.100 -	0.004	0.008
D	W. A.	19.80	20.20	M. 100	0.780	0.795
D1	MA	18.30	18.50	W 10	0.720	0.728
ELTW	Al A	7.90	8.10	WW.1	0.311	0.319
е	0.50	1907.0	MIT	0.020	$\overline{OO_X}$	_
Y.CL M.T	N N	0.50	0.70	N. A.	0.020	0.028
α	IN	0° 00 1	5°	Mari	V100°	5°
NON	WT	32	CONTY	MW.	32	MITW
CP	W	WWW	0.10		4. 100 X.C.	0.004

Figure 12. TSOP32 - 32 lead Plastic Thin Small Outline, 8 x 20 mm, Package Outline